Smart Highside High Current Power Switch   Reversave™

Features
- Overload protection
- Current limitation
- Short circuit protection
- Over temperature protection
- Over voltage protection (including load dump)
- Clamp of negative voltage at output
- Fast deenergizing of inductive loads [1]
- Low ohmic inverse current operation
- **Reversave™** (Reverse battery protection)
- Diagnostic feedback with load current sense
- Open load detection via current sense
- Loss of V_{bb} protection [2]
- **E**lectro**s**tatic **d**ischarge (**ESD**) protection

Application
- Power switch with current sense diagnostic feedback for 12 V and 24 V DC grounded loads
- Most suitable for loads with high inrush current like lamps and motors; all types of resistive and inductive loads
- Replaces electromechanical relays, fuses and discrete circuits

Product Summary

Overvoltage protection	$V_{bb(AZ)}$	62	V
Output clamp	$V_{ON(CL)}$	42	V
Operating voltage	$V_{bb(on)}$	5.0 ... 34	V
On-state resistance	R_{ON}	6.0	mΩ
Load current (ISO)	$I_{L(ISO)}$	70	A
Short circuit current limitation	$I_{L(SC)}$	130	A
Current sense ratio	$I_L : I_{IS}$	14 000	

TO-220-7

Standard   SMD

General Description
N channel vertical power FET with charge pump, current controlled input and diagnostic feedback with load current sense, integrated in Smart SIPMOS® chip on chip technology. Providing embedded protective functions.

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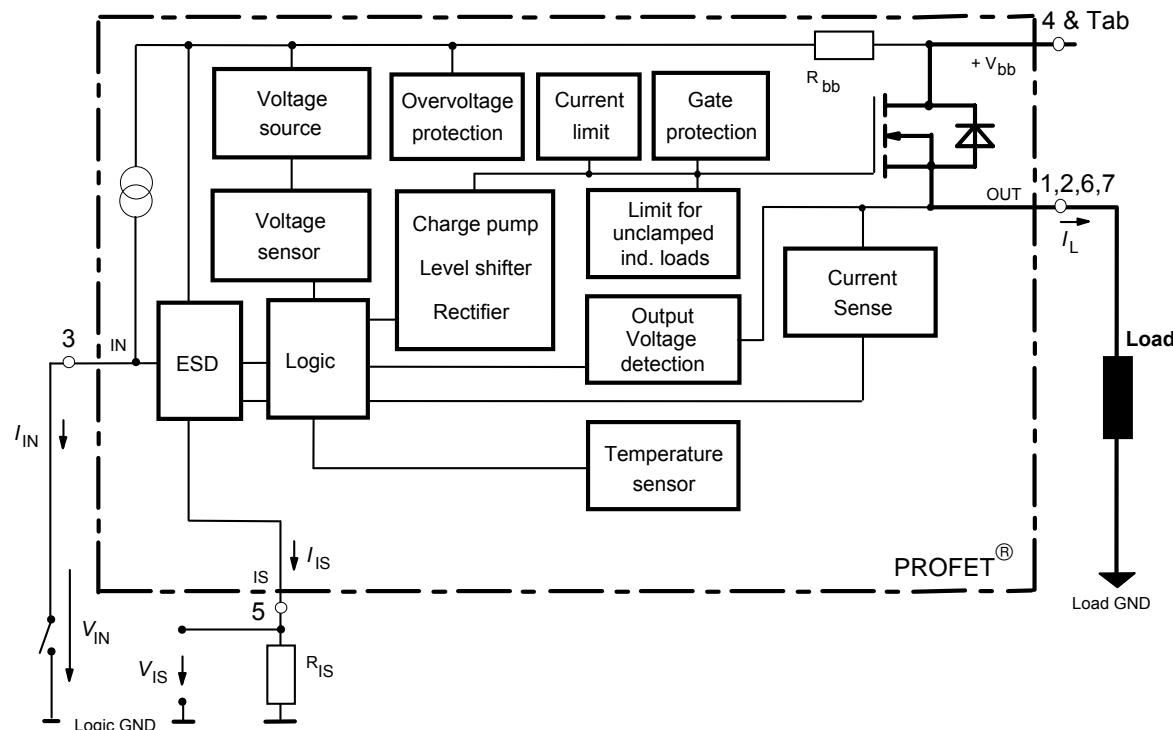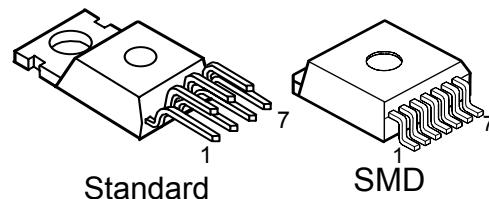
[1] With additional external diode.
[2] Additional external diode required for energized inductive loads (see page 9).

Pin	Symbol		Function
1	OUT	O	**Output**; output to the load; pin 1, 2, 6 and 7 must be externally shorted with each other especially in high current applications. [3]
2	OUT	O	**Output**; output to the load; pin 1, 2, 6 and 7 must be externally shorted with each other especially in high current applications. [3]
3	IN	I	**Input**; has an internal pull up; activates the power switch in case of short to ground
4	Vbb	+	**Supply voltage**; positive power supply voltage; tab and pin 4 are internally shorted; in high current applications use the tab [4].
5	IS	S	**Sense Output**; Diagnostic feedback; provides a sense current proportional to the load current; zero current on failure (see Truth Table on page 7)
6	OUT	O	**Output**; output to the load; pin 1, 2, 6 and 7 must be externally shorted with each other especially in high current applications. [3]
7	OUT	O	**Output**; output to the load; pin 1, 2, 6 and 7 must be externally shorted with each other especially in high current applications. [3]

Maximum Ratings at T_j = 25 °C unless otherwise specified

Parameter	Symbol	Values	Unit
Supply voltage (over voltage protection see page 4)	V_{bb}	42	V
Supply voltage for short circuit protection, $T_{j,start}$ =-40 ...+150°C: (see diagram on page 10)	V_{bb}	34	V
Load current (short circuit current, see page 5)	I_L	self-limited	A
Load dump protection $V_{LoadDump} = V_A + V_s$, $V_A = 13.5\,V$ $R_I{}^{5)} = 2\,\Omega$, $R_L = 0.54\,\Omega$, $t_d = 200\,ms$, IN, IS = open or grounded	$V_{Load\,dump}{}^{6)}$	75	V
Operating temperature range Storage temperature range	T_j T_{stg}	-40 ...+150 -55 ...+150	°C
Power dissipation (DC), $T_C \le 25\,°C$	P_{tot}	170	W
Inductive load switch-off energy dissipation, single pulse $V_{bb} = 12V$, $T_{j,start} = 150°C$, $T_C = 150°C$ const., $I_L = 20\,A$, $Z_L = 7.5\,mH$, $0\,\Omega$, see diagrams on page 10	E_{AS}	1.5	J
Electrostatic discharge capability (ESD) Human Body Model acc. MIL-STD883D, method 3015.7 and ESD assn. std. S5.1-1993, C = 100 pF, R = 1.5 kΩ	V_{ESD}	4	kV
Current through input pin (DC) Current through current sense status pin (DC) see internal circuit diagrams on page 8 and 9	I_{IN} I_{IS}	+15 , -250 +15 , -250	mA

[3] Not shorting all outputs will considerably increase the on-state resistance, reduce the peak current capability and decrease the current sense accuracy

[4] Otherwise add up to 0.7 mΩ (depending on used length of the pin) to the R_{ON} if the pin is used instead of the tab.

[5] R_I = internal resistance of the load dump test pulse generator.

[6] $V_{Load\,dump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839.

Thermal Characteristics

Parameter and Conditions	Symbol	Values			Unit
		min	typ	max	
Thermal resistance chip - case:	R_{thJC} [7]	--	--	0.75	K/W
junction - ambient (free air):	R_{thJA}	--	60	--	
SMD version, device on PCB [8]:		--	33	40	

Electrical Characteristics

Parameter and Conditions at T_j = -40 ... +150 °C, V_{bb} = 12 V unless otherwise specified	Symbol	Values			Unit
		min	typ	max	

Load Switching Capabilities and Characteristics

Parameter and Conditions	Symbol	min	typ	max	Unit
On-state resistance (Tab to pins 1,2,6,7, see measurement circuit page 7) I_L = 20 A, T_j = 25 °C:	R_{ON}	--	4.4	6.0	mΩ
V_{IN} = 0, I_L = 20 A, T_j = 150 °C:			7.9	10.5	
I_L = 90 A, T_j = 150 °C:			--	10.7	
V_{bb} = 6V [9], I_L = 20 A, T_j = 150 °C:	$R_{ON(Static)}$	--	10	17	
Nominal load current [10] (Tab to pins 1, 2, 6, 7) ISO 10483-1/6.7: V_{ON} = 0.5 V, T_C = 85 °C [11]	$I_{L(ISO)}$	55	70	--	A
Nominal load current [10], device on PCB [8] T_A = 85 °C, $T_j \le$ 150 °C $V_{ON} \le$ 0.5 V,	$I_{L(NOM)}$	13.6	17	--	A
Maximum load current in resistive range (Tab to pins 1, 2, 6, 7) V_{ON} = 1.8 V, T_C = 25 °C:	$I_{L(Max)}$	250	--	--	
see diagram on page 13 V_{ON} = 1.8 V, T_C = 150 °C:		150	--	--	A
Turn-on time [12] I_{IN} ⌐ to 90% V_{OUT}:	t_{on}	100	--	420	µs
Turn-off time I_{IN} ⌐ to 10% V_{OUT}:	t_{off}	30	--	110	
R_L = 1 Ω , T_j = -40...+150°C					
Slew rate on [12] (10 to 30% V_{OUT}) R_L = 1 Ω , T_J = 25 °C	dV/dt_{on}	--	0.7	--	V/µs
Slew rate off [12] (70 to 40% V_{OUT}) R_L = 1 Ω , T_J = 25 °C	-dV/dt_{off}	--	1.1	--	V/µs

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[7] Thermal resistance R_{thCH} case to heatsink (about 0.5 ... 0.9 K/W with silicone paste) not included!

[8] Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm^2 (one layer, 70µm thick) copper area for V_{bb} connection. PCB is vertical without blown air.

[9] Decrease of V_{bb} below 10 V causes slowly a dynamic increase of R_{ON} to a higher value of $R_{ON(Static)}$. As long as $V_{bIN} > V_{bIN(u) max}$, R_{ON} increase is less than 10 % per second for $T_J < 85$ °C.

[10] not subject to production test, specified by design

[11] T_J is about 105°C under these conditions.

[12] See timing diagram on page 14.

Parameter and Conditions		Symbol	Values			Unit
at T_j = -40 ... +150 °C, V_{bb} = 12 V unless otherwise specified			min	typ	max	

Inverse Load Current Operation

Parameter and Conditions		Symbol	min	typ	max	Unit
On-state resistance (Pins 1, 2, 6, 7 to pin 4)						
V_{bIN} = 12 V, I_L = -20 A T_j = 25 °C:		$R_{ON(inv)}$	--	4.4	6.0	mΩ
see diagram on page 10 T_j = 150 °C:				7.9	10.5	
Nominal inverse load current (Pins 1, 2, 6, 7 to Tab)		$I_{L(inv)}$	55	70	--	A
V_{ON} = -0.5 V, T_C = 85 °C[11]						
Drain-source diode voltage (V_{out} > V_{bb})		$-V_{ON}$	--	0.6	--	V
I_L = -20 A, I_{IN} = 0, T_j = +150°C						

Operating Parameters

Parameter and Conditions		Symbol	min	typ	max	Unit
Operating voltage (V_{IN} = 0V) [13]		$V_{bb(on)}$	5.0	--	34	V
Under voltage shutdown [14]		$V_{bIN(u)}$	1.5	3.0	4.5	V
Under voltage start of charge pump						
see diagram page 15		$V_{bIN(ucp)}$	3.0	4.5	6.0	V
Over voltage protection [15] T_j = -40°C:		$V_{Z,IN}$	60	--	--	V
I_{bb} = 15 mA T_j = 25...+150°C:			62	66	--	
Standby current T_j = -40...+25°C:		$I_{bb(off)}$	--	15	25	µA
I_{IN} = 0 T_j = 150°C:			--	25	50	

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[13] If the device is turned on before a V_{bb}-decrease, the operating voltage range is extended down to $V_{bIN(u)}$.
    For all voltages 0 ... 34 V the device is fully protected against overtemperature and short circuit.

[14] V_{bIN} = V_{bb} - V_{IN} see diagram on page 7. When V_{bIN} increases from less than $V_{bIN(u)}$ up to $V_{bIN(ucp)}$ = 5 V
    (typ.) the charge pump is not active and $V_{OUT} \approx V_{bb}$ - 3 V.

[15] See also $V_{ON(CL)}$ in circuit diagram on page 9.

Protection Functions [16]

Parameter and Conditions at $T_j = -40 ... +150\,°C$, $V_{bb} = 12\,V$ unless otherwise specified	Symbol	Values			Unit
		min	typ	max	
Short circuit current limit (Tab to pins 1, 2, 6, 7)					
$V_{ON} = 12\,V$, time until shutdown max. 350 µs $T_c = -40°C$:	$I_{L(SC)}$	--	110	--	A
$T_c = 25°C$:	$I_{L(SC)}$	--	130	180	
$T_c = +150°C$:	$I_{L(SC)}$	65	115	--	
Short circuit shutdown delay after input current positive slope, $V_{ON} > V_{ON(SC)}$ min. value valid only if input "off-signal" time exceeds 30 µs	$t_{d(SC)}$	80	--	350	µs
Output clamp [17] $I_L = 40\,mA$: (inductive load switch off) see diagram Ind. and overvolt. output clamp page 8	$-V_{OUT(CL)}$	14	16.5	20	V
Output clamp (inductive load switch off) at $V_{OUT} = V_{bb} - V_{ON(CL)}$ (e.g. over voltage) $I_L = 40\,mA$	$V_{ON(CL)}$	39	42	47	V
Short circuit shutdown detection voltage (pin 4 to pins 1,2,6,7)	$V_{ON(SC)}$	--	6	--	V
Thermal overload trip temperature	T_{jt}	150	--	--	°C
Thermal hysteresis	ΔT_{jt}	--	10	--	K

Reverse Battery

Parameter and Conditions	Symbol	min	typ	max	Unit
Reverse battery voltage [18]	$-V_{bb}$	--	--	16	V
On-state resistance (Pins 1 ,2 ,6 ,7 to pin 4) $T_j = 25\,°C$: $V_{bb} = -12V$, $V_{IN} = 0$, $I_L = -20\,A$, $R_{IS} = 1\,k\Omega$ $T_j = 150\,°C$:	$R_{ON(rev)}$	-- 	5.4 8.9	7.0 12.3	mΩ
Integrated resistor in V_{bb} line	R_{bb}	--	120	--	Ω

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[16] Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

[17] This output clamp can be "switched off" by using an additional diode at the IS-Pin (see page 8). If the diode is used, V_{OUT} is clamped to $V_{bb} - V_{ON(CL)}$ at inductive load switch off.

[18] The reverse load current through the intrinsic drain-source diode has to be limited by the connected load (as it is done with all polarity symmetric loads). Note that under off-conditions ($I_{IN} = I_{IS} = 0$) the power transistor is not activated. This results in raised power dissipation due to the higher voltage drop across the intrinsic drain-source diode. The temperature protection is not active during reverse current operation! Increasing reverse battery voltage capability is simply possible as described on page 9.

Parameter and Conditions	Symbol	Values			Unit
at T_j = -40 ... +150 °C, V_{bb} = 12 V unless otherwise specified		min	typ	max	

Diagnostic Characteristics

Parameter and Conditions		Symbol	min	typ	max	Unit
Current sense ratio, static on-condition, k_{ILIS} = I_L : I_{IS}, V_{ON} < 1.5 V [19], V_{IS} < V_{OUT} - 5V, V_{bIN} > 4.0 V see diagram on page 12	I_L = 90 A, T_j = -40°C:	k_{ILIS}	12 500	14 200	16 000	
	T_j = 25°C:		12 500	13 700	16 000	
	T_j = 150°C:		11 500	13 000	14 500	
	I_L = 20 A, T_j = -40°C:		12 500	14 500	17 500	
	T_j = 25°C:		12 000	14 000	16 500	
	T_j = 150°C:		11 500	13 400	15 000	
	I_L = 10 A, T_j = -40°C:		12 500	15 000	19 000	
	T_j = 25°C:		11 500	14 300	17 500	
	T_j = 150°C:		11 500	13 500	15 500	
	I_L = 4 A, T_j = -40°C:		11 000	18 000	28 500	
	T_j = 25°C:		11 000	15 400	22 000	
	T_j = 150°C:		11 200	14 000	19 000	
I_{IS}=0 by I_{IN} =0 (e.g. during deenergizing of inductive loads):						
Sense current saturation		$I_{IS,lim}$	6.5	--	--	mA
Current sense leakage current	I_{IN} = 0:	$I_{IS(LL)}$	--	--	0.5	μA
	V_{IN} = 0, I_L ≤ 0:	$I_{IS(LH)}$	--	2	65	
Current sense over voltage protection I_{bb} = 15 mA	T_j = -40°C:	$V_{Z,IS}$	60	--	--	V
	T_j = 25...+150°C:		62	66	--	
Current sense settling time [20]		$t_{s(IS)}$	--	--	500	μs

Input

Parameter and Conditions	Symbol	min	typ	max	Unit
Input and operating current (see diagram page 13) IN grounded (V_{IN} = 0)	$I_{IN(on)}$	--	0.8	1.5	mA
Input current for turn-off [21]	$I_{IN(off)}$	--	--	80	μA

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[19] If V_{ON} is higher, the sense current is no longer proportional to the load current due to sense current saturation, see $I_{IS,lim}$.

[20] not subject to production test, specified by design

[21] We recommend the resistance between IN and GND to be less than 0.5 kΩ for turn-on and more than 500 kΩ for turn-off. Consider that when the device is switched off (I_{IN} = 0) the voltage between IN and GND reaches almost V_{bb}.

Truth Table

	Input current level	Output level	Current Sense I_{IS}	Remark
Normal operation	L H	L H	0 nominal	$=I_L / k_{ilis}$, up to $I_{IS}=I_{IS,lim}$
Very high load current	H	H	$I_{IS, lim}$	up to $V_{ON}=V_{ON(Fold\ back)}$ I_{IS} no longer proportional to I_L
Current-limitation	H	H	0	$V_{ON} > V_{ON(Fold\ back)}$ if $V_{ON}>V_{ON(SC)}$, shutdown will occur
Short circuit to GND	L H	L L	0 0	
Over temperature	L H	L L	0 0	
Short circuit to V_{bb}	L H	H H	0 <nominal [22]	
Open load	L H	Z[23] H	0 0	
Negative output voltage clamp	L	L	0	
Inverse load current	L H	H H	0 0	

L = "Low" Level; H = "High" Level

Over temperature reset by cooling: $T_j < T_{jt}$ (see diagram on page 15)

Short circuit to GND: Shutdown remains latched until next reset via input (see diagram on page 14)

Terms
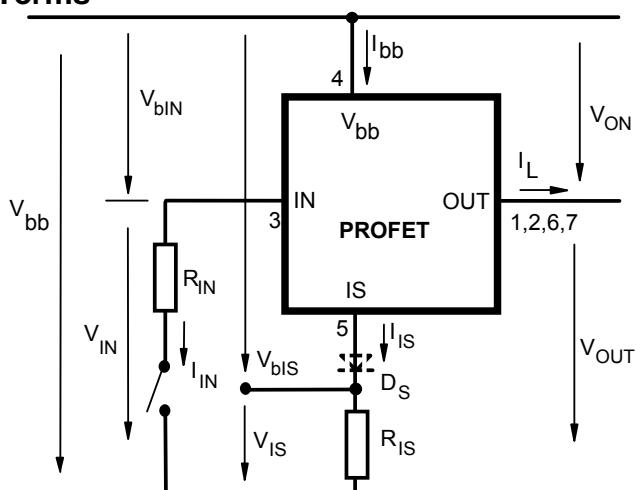
Two or more devices can easily be connected in parallel to increase load current capability.

R_{ON} measurement layout
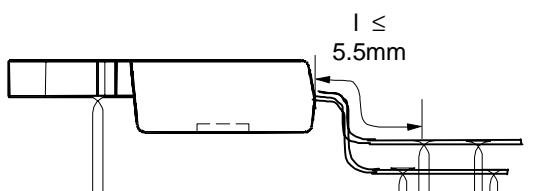
Typical R_{ON} for SMD version is about 0.2 mΩ less than straight leads due to l ≈ 2 mm

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[22] Low ohmic short to V_{bb} may reduce the output current I_L and can thus be detected via the sense current I_{IS}.

[23] Power Transistor "OFF", potential defined by external impedance.

Input circuit (ESD protection)
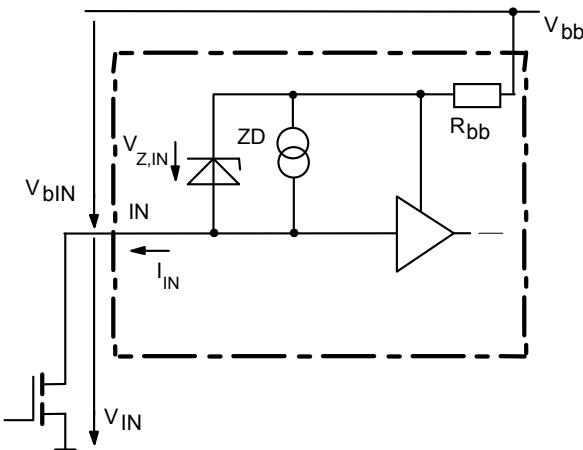
When the device is switched off ($I_{IN} = 0$) the voltage between IN and GND reaches almost V_{bb}. Use a mechanical switch, a bipolar or MOS transistor with appropriate breakdown voltage as driver.
$V_{Z,IN} = 66V$ (typ).

Short circuit detection

Fault Condition: $V_{ON} > V_{ON(SC)}$ (6 V typ.) and t> $t_{d(SC)}$ (80 ...350 µs).
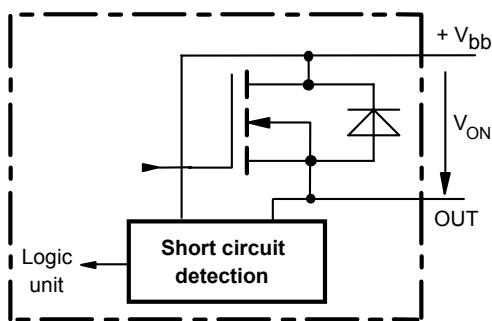
Current sense status output
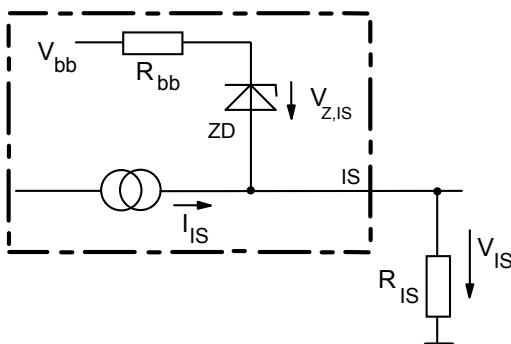
$V_{Z,IS} = 66V$ (typ.), $R_{IS} = 1 k\Omega$ nominal (or 1 kΩ /n, if n devices are connected in parallel). $I_S = I_L/k_{ilis}$ can be driven only by the internal circuit as long as $V_{out} - V_{IS} > 5$ V. If you want measure load currents up to $I_{L(M)}$, R_{IS} should be less than $\dfrac{V_{bb} - 5\ V}{I_{L(M)} / K_{ilis}}$.

Note: For large values of R_{IS} the voltage V_{IS} can reach almost V_{bb}. See also over voltage protection.
If you don't use the current sense output in your application, you can leave it open.

Inductive and over voltage output clamp
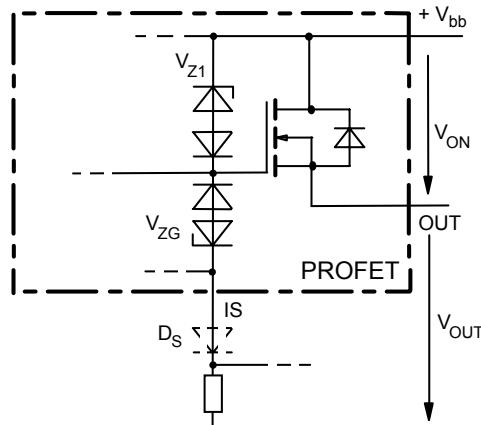
V_{ON} is clamped to $V_{ON(Cl)} = 42$ V typ. At inductive load switch-off without D_S, V_{OUT} is clamped to $V_{OUT(CL)} = -19$ V typ. via V_{ZG}. With D_S, V_{OUT} is clamped to $V_{bb} - V_{ON(CL)}$ via V_{Z1}. Using D_S gives faster deenergizing of the inductive load, but higher peak power dissipation in the PROFET. In case of a floating ground with a potential higher than 19V referring to the OUT – potential the device will switch on, if diode DS is not used.

Over voltage protection of logic part
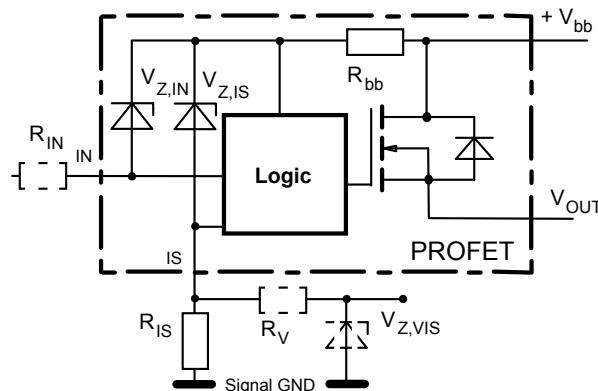
$R_{bb} = 120\,\Omega$ typ., $V_{Z,IN} = V_{Z,IS} = 66\,V$ typ., $R_{IS} = 1\,k\Omega$ nominal. Note that when over voltage exceeds 71 V typ. a voltage above 5V can occur between IS and GND, if R_V, $V_{Z,VIS}$ are not used.

Reverse battery protection
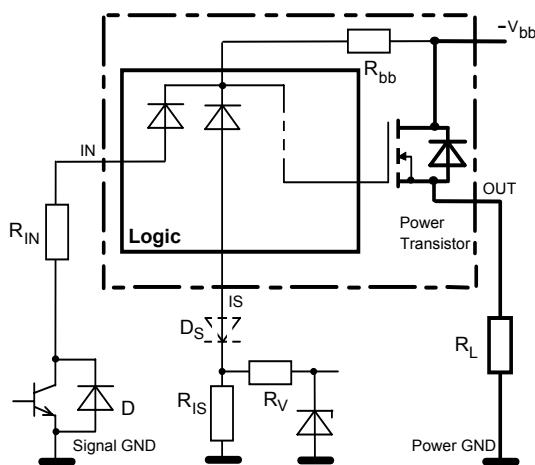
$R_V \geq 1\,k\Omega$, $R_{IS} = 1\,k\Omega$ nominal. Add R_{IN} for reverse battery protection in applications with Vbb above 16 V[18]; recommended value:

$$\frac{1}{R_{IN}} + \frac{1}{R_{IS}} + \frac{1}{R_V} = \frac{0.1A}{|V_{bb}| - 12V} \text{ if } D_S \text{ is not used (or}$$

$$\frac{1}{R_{IN}} = \frac{0.1A}{|V_{bb}| - 12V} \text{ if } D_S \text{ is used).}$$

To minimize power dissipation at reverse battery operation, the summarized current into the IN and IS pin should be about 120mA. The current can be provided by using a small signal diode D in parallel to the input switch, by using a MOSFET input switch or by proper adjusting the current through R_{IS} and R_V.

Vbb disconnect with energized inductive load

Provide a current path with load current capability by using a diode, a Z-diode, or a varistor. ($V_{ZL} < 72$ V or $V_{Zb} < 30$ V if $R_{IN}=0$). For higher clamp voltages currents at IN and IS have to be limited to 250 mA.

Version a:
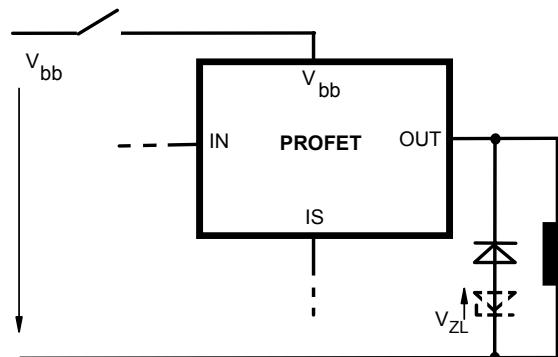
Version b:
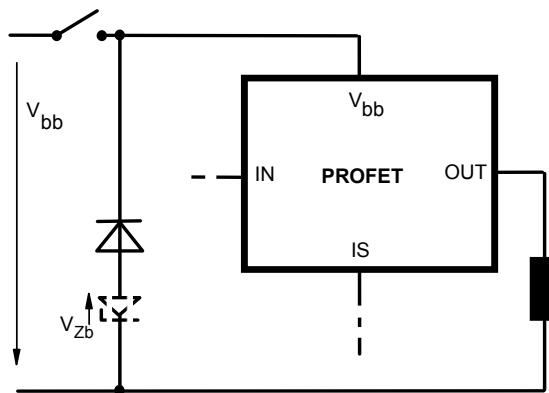
Note that there is no reverse battery protection when using a diode without additional Z-diode V_{ZL}, V_{Zb}.

Version c: Sometimes a necessary voltage clamp is given by non inductive loads R_L connected to the same switch and eliminates the need of clamping circuit:
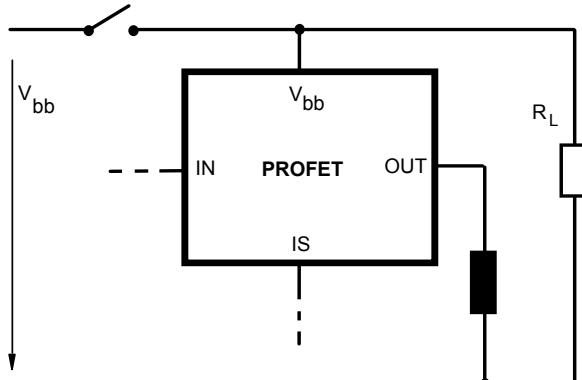
Inverse load current operation
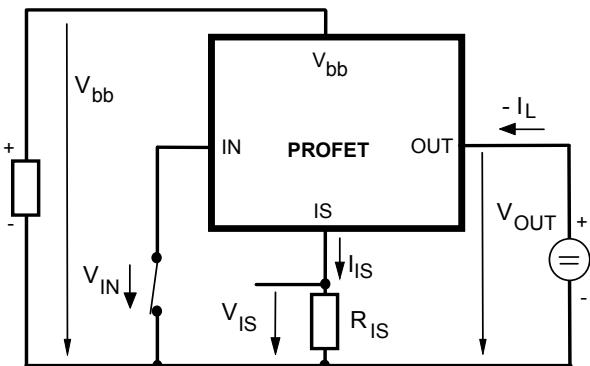
The device is specified for inverse load current operation ($V_{OUT} > V_{bb}$ **> 0V**). The current sense feature is not available during this kind of operation ($I_{IS} = 0$). With $I_{IN} = 0$ (e.g. input open) only the intrinsic drain source diode is conducting resulting in considerably increased power dissipation. If the device is switched on ($V_{IN} = 0$), this power dissipation is decreased to the much lower value $R_{ON(INV)} * I^2$ (specifications see page 4).
Note: *Temperature protection during inverse load current operation is not possible!*

Inductive load switch-off energy dissipation
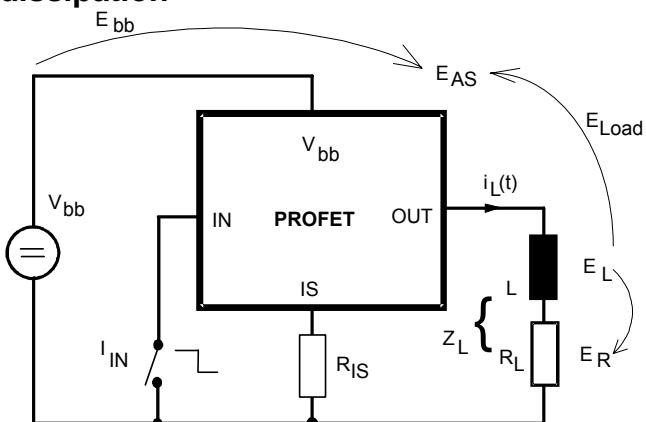
Energy stored in load inductance:

$$E_L = {}^1/_2 \cdot L \cdot I_L^2$$

While demagnetizing load inductance, the energy dissipated in PROFET is

$$E_{AS} = E_{bb} + E_L - E_R = \int V_{ON(CL)} \cdot i_L(t)\, dt,$$

with an approximate solution for $R_L > 0\,\Omega$:

$$E_{AS} = \frac{I_L \cdot L}{2 \cdot R_L}\left(V_{bb} + |V_{OUT(CL)}|\right)\, ln\,\left(1 + \frac{I_L \cdot R_L}{|V_{OUT(CL)}|}\right)$$

Maximum allowable load inductance for a single switch off

$L = f(I_L)$; $T_{j,start} = 150°C$, $V_{bb} = 12\,V$, $R_L = 0\,\Omega$

L [µH]

I_L [A]
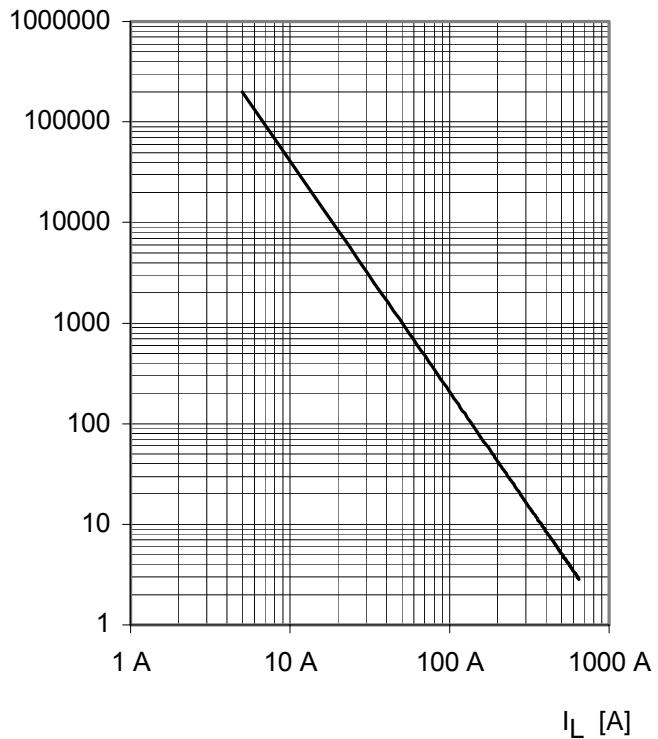
Externally adjustable current limit

If the device is conducting, the sense current can be used to reduce the short circuit current and allow higher lead inductance (see diagram above). The device will be turned off, if the threshold voltage of T2 is reached by $I_s * R_{IS}$. After a delay time defined by $R_V * C_V$ T1 will be reset. The device is turned on again, the short circuit current is defined by $I_{L(SC)}$ and the device is shut down after $t_{d(SC)}$ with latch function.
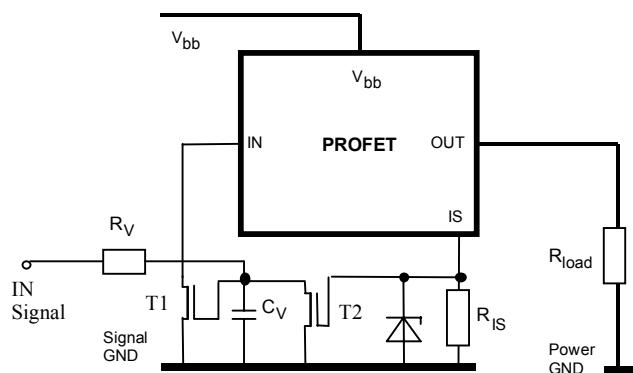
Options Overview

Type BTS	6510	550P 650P	555
Over temperature protection with hysteresis	X	X	X
T_j >150 °C, latch function[24]			X
T_j >150 °C, with auto-restart on cooling	X	X	
Short circuit to GND protection			
with over temperature shutdown	X		
switches off when V_{ON}>6 V typ. (when first turned on after approx. 180 μs)		X	X
Over voltage shutdown	-	-	-
Output negative voltage transient limit			
to V_{bb} - $V_{ON(CL)}$	X	X	X
to V_{OUT} = -19 V typ	X[25]	X[25]	X[25]

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[24] Latch except when V_{bb} - V_{OUT} < $V_{ON(SC)}$ after shutdown. In most cases V_{OUT} = 0 V after shutdown ($V_{OUT} \neq$ 0 V only if forced externally). So the device remains latched unless V_{bb} < $V_{ON(SC)}$ (see page 5). No latch between turn on and $t_{d(SC)}$.

[25] Can be "switched off" by using a diode D_S (see page 8) or leaving open the current sense output.

Characteristics

Current sense versus load current:
$I_{IS} = f(I_L)$, T_J= -40 ... +150 °C

I_{IS} [mA]

I_L [A]

Current sense ratio:
$I_{IS} = f(I_L)$, T_J= 25 °C

k_{ILIS}

I_L [A]
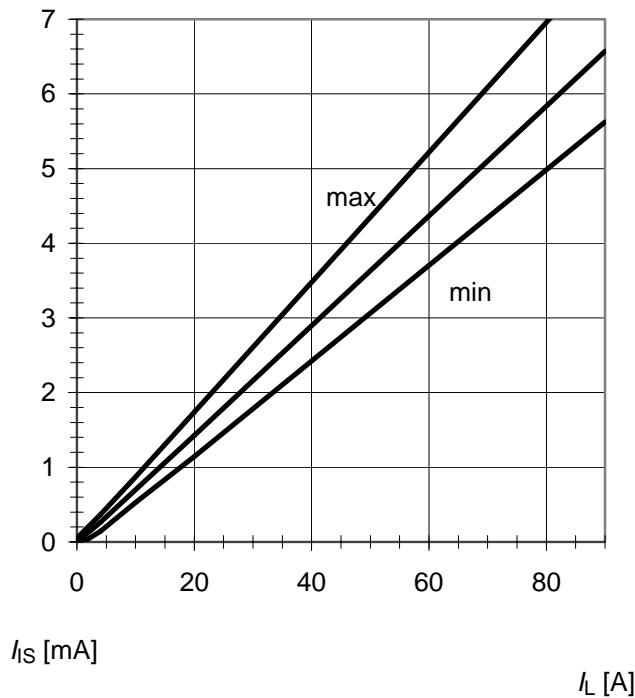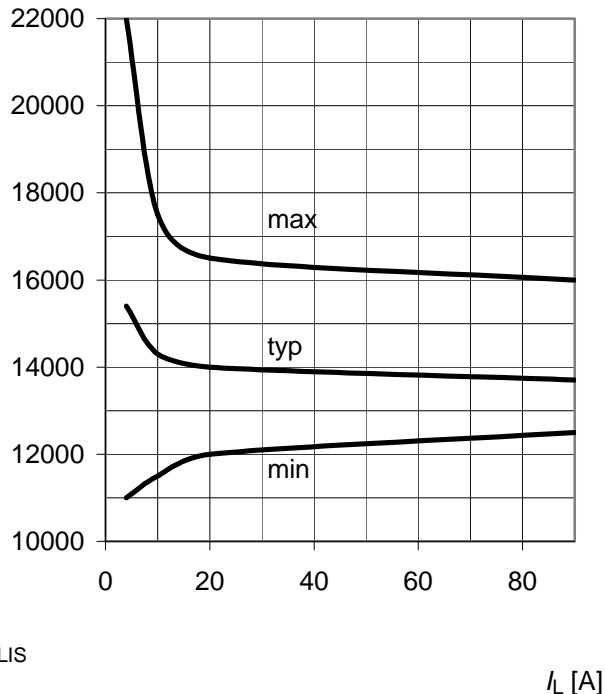
Current sense ratio:
$K_{ILIS} = f(I_L)$, T_J = -40°C
k_{ilis}

I_L [A]
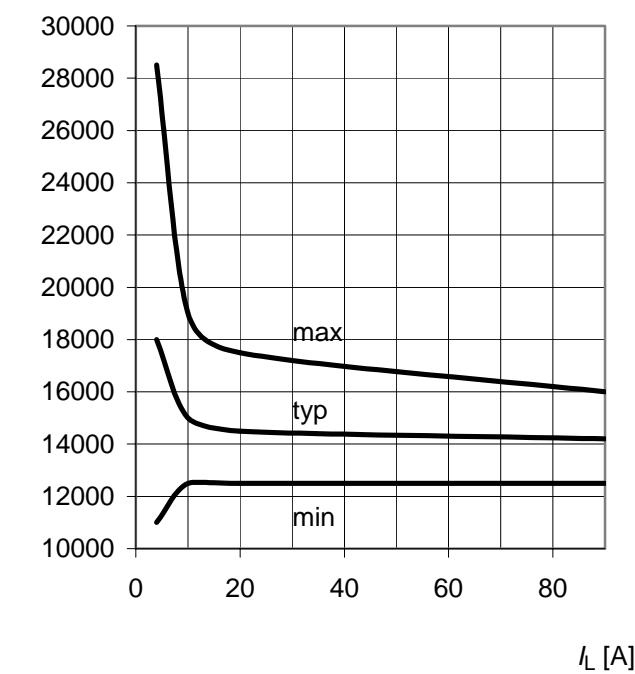
Current sense ratio:
$K_{ILIS} = f(I_L)$, T_J = 150°C

k_{ilis}

I_L [A]
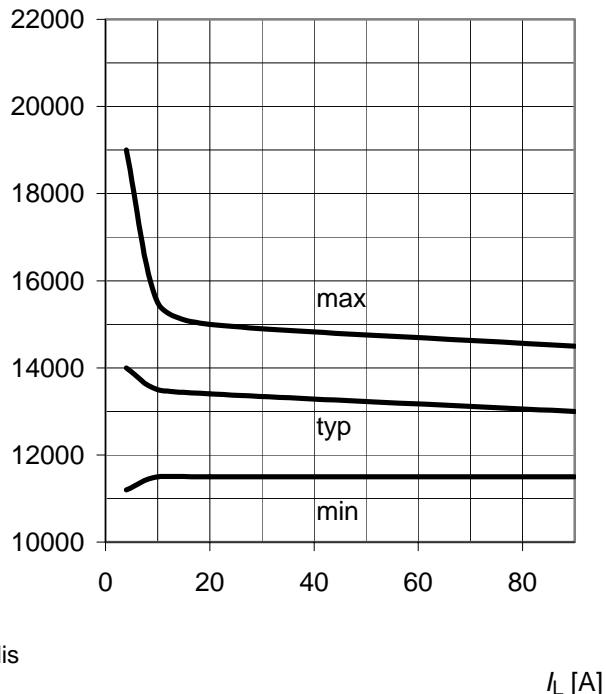
Typ. current limitation characteristic
$I_L = f(V_{ON}, T_j)$

I_L [A]
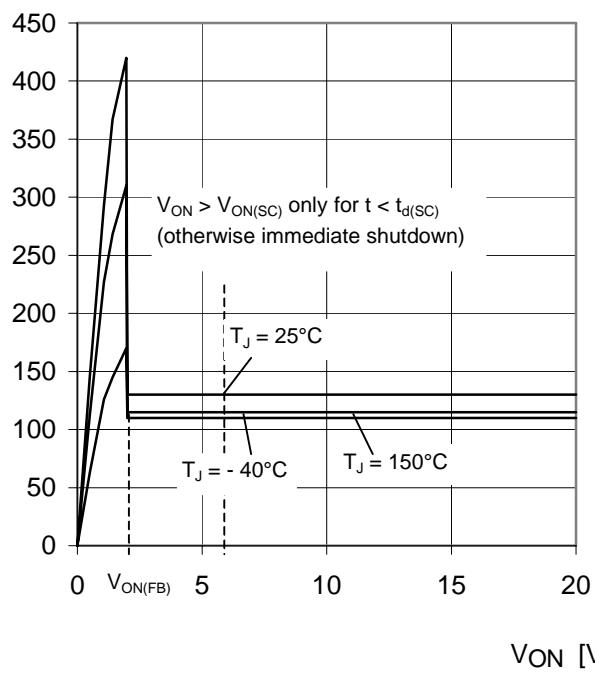
V_{ON} [V]

In case of $V_{ON} > V_{ON(SC)}$ (typ. 6 V) the device will be switched off by internal short circuit detection.

Typ. on-state resistance
$R_{ON} = f(V_{bb}, T_j)$; $I_L = 20$ A; $V_{IN} = 0$

R_{ON} [mOhm]
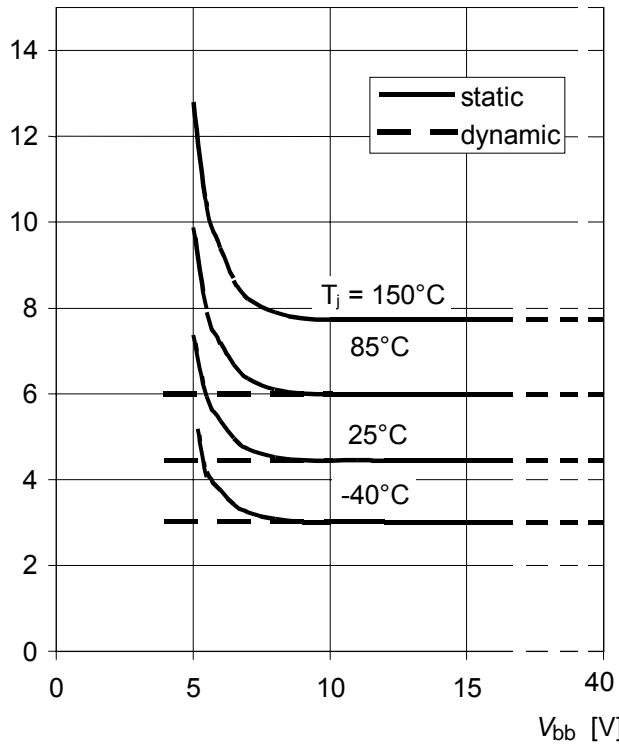
V_{bb} [V]

Typ. input current
$I_{IN} = f(V_{bIN})$, $V_{bIN} = V_{bb} - V_{IN}$
I_{IN} [mA]
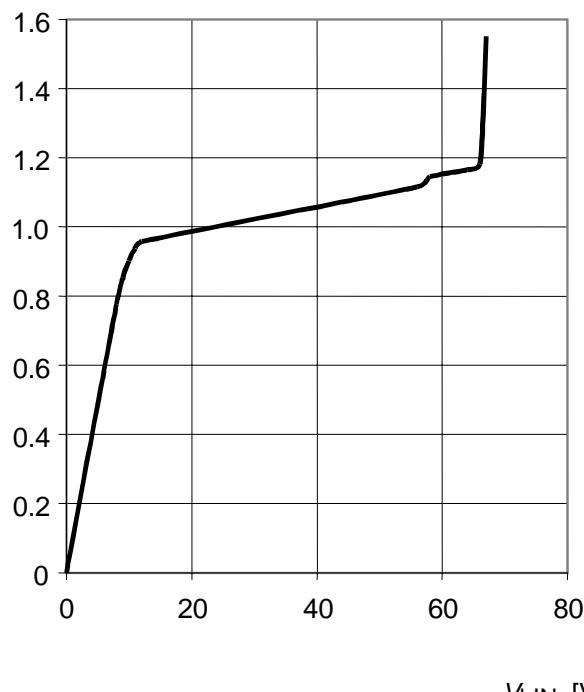
V_{bIN} [V]

Timing diagrams

Figure 1a: Switching a resistive load, change of load current in on-condition:
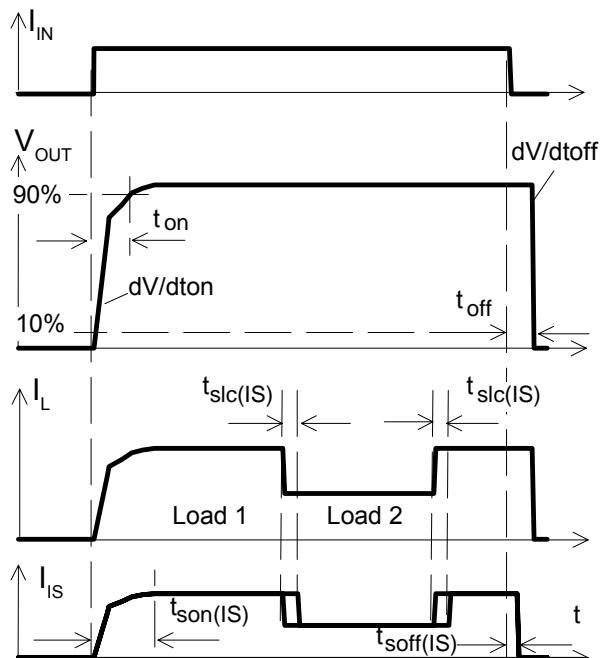
The sense signal is not valid during a settling time after turn-on/off and after change of load current.

Figure 2b: Switching motors and lamps:
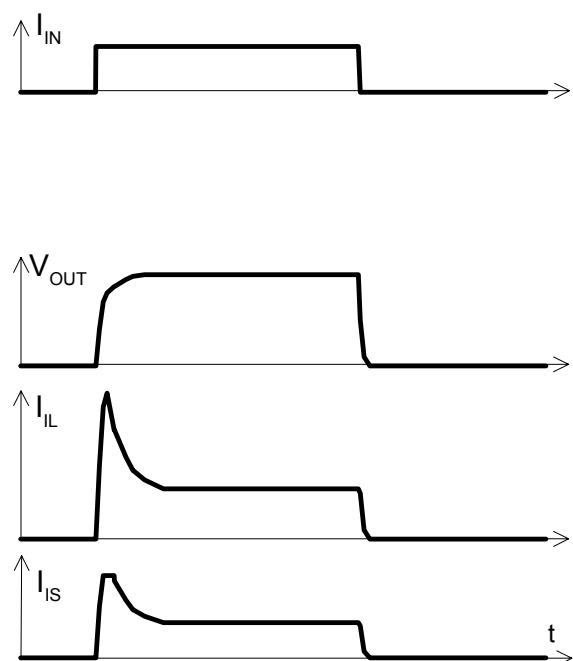
Sense current saturation can occur at very high inrush currents (see $I_{IS,lim}$ on page 6).

Figure 2c: Switching an inductive load:
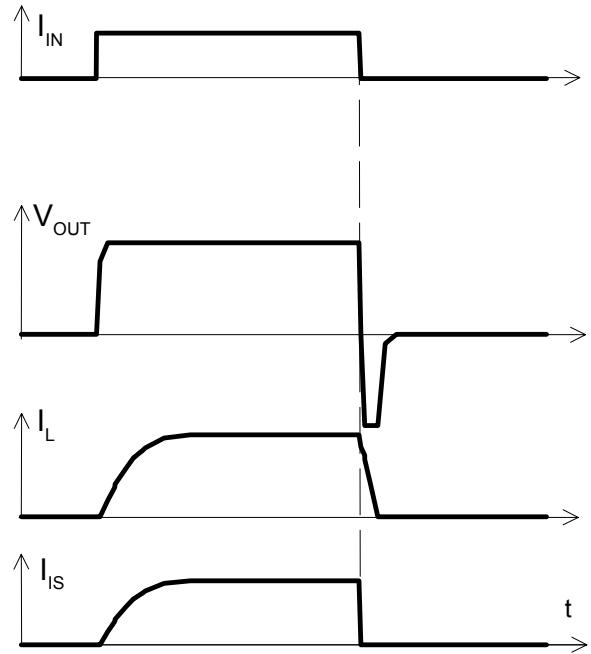
Figure 3d: Short circuit: shut down by short circuit detection, reset by $I_{IN} = 0$.
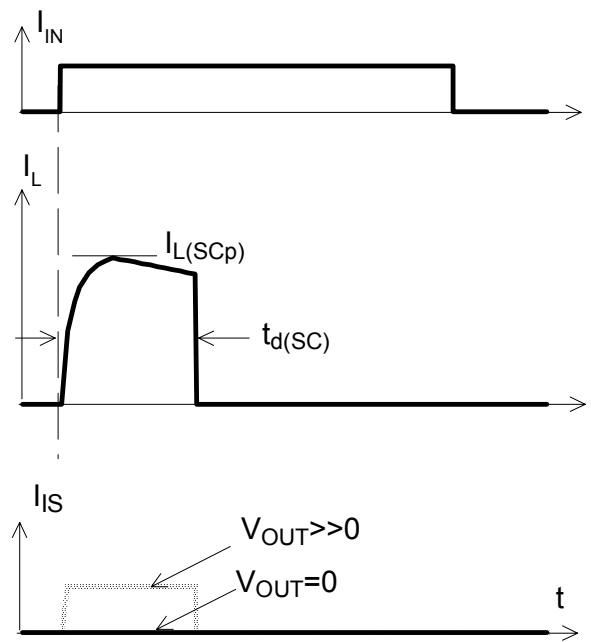
Shut down remains latched until next reset via input.

Figure 4e: Over temperature
Reset if $T_j < T_{jt}$
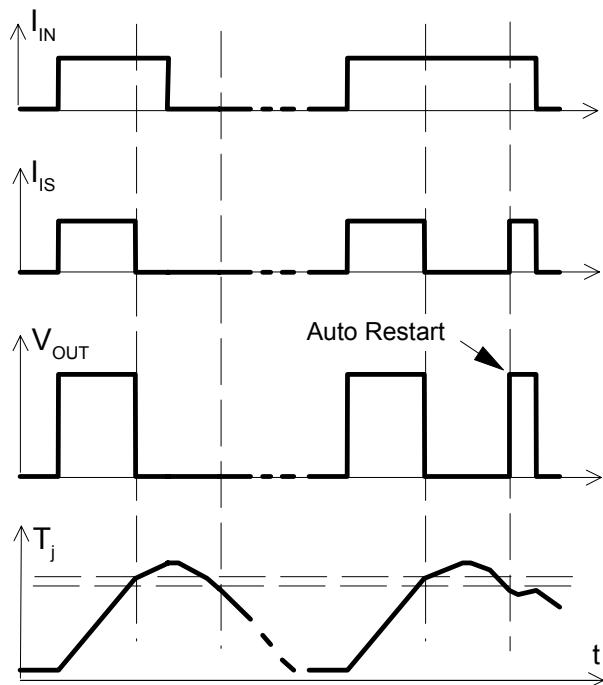
Figure 6f: Under voltage restart of charge pump,
over voltage clamp
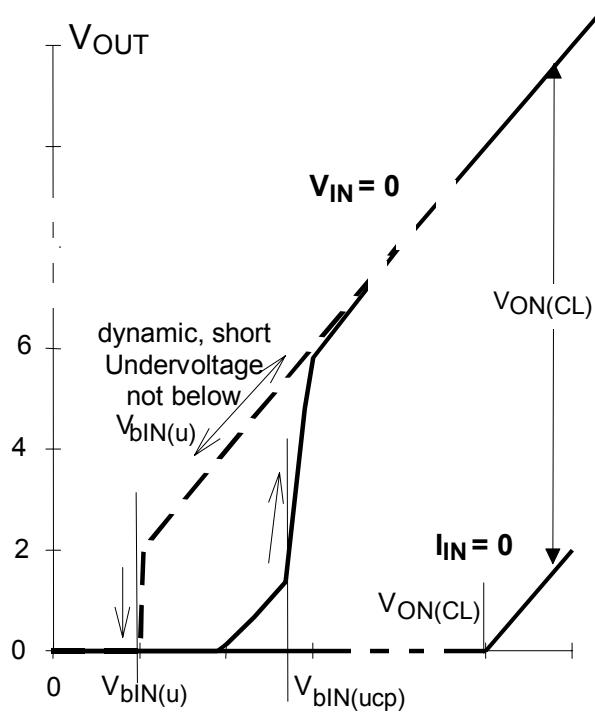
Package and Ordering Code

All dimensions in mm

Standard: TO-220-7-3

Ordering code

BTS650P	Q67060-S6308-A002

1) shear and punch direction no burrs this surface
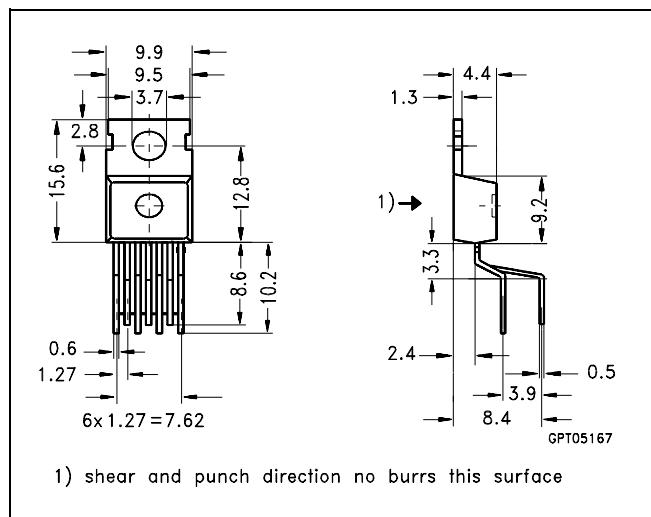
SMD: TO220-7-180

Ordering code

BTS650P E3180A	T&R:	Q67060-S6308-A004

Footprint: